

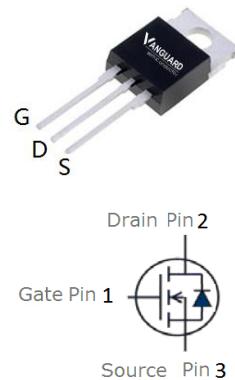
## Features

- N-Channel, 5V Logic Level Control
- Enhancement mode
- Fast Switching
- Very low on-resistance  $R_{DS(on)}$  @  $V_{GS}=4.5\text{ V}$
- 100% Avalanche test
- Pb-free lead plating; RoHS compliant

$V_{DS}$	120	V
$R_{DS(on),TYP}$ @ $V_{GS}=10\text{ V}$	11.5	$\text{m}\Omega$
$R_{DS(on),TYP}$ @ $V_{GS}=4.5\text{ V}$	13	$\text{m}\Omega$
$I_D$	63	A

**TO-220AB**


Part ID	Package Type	Marking	Tape and reel information
VST012N12MS	TO-220AB	012N12M	50pcs/Tube



**Maximum ratings**, at  $T_j=25\text{ }^\circ\text{C}$ , unless otherwise specified

Symbol	Parameter	Rating	Unit	
<b>Common Ratings (Tc=25°C Unless Otherwise Noted)</b>				
$V_{GS}$	Gate-Source Voltage	±20	V	
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage	120	V	
$T_J$	Maximum Junction Temperature	175	°C	
$T_{STG}$	Storage Temperature Range	-55 to 175	°C	
$I_S$	Diode Continuous Forward Current	$T_c=25\text{ }^\circ\text{C}$	A	
<b>Mounted on Large Heat Sink</b>				
$I_D$	Continuous Drain current@ $V_{GS}=10\text{ V}$	$T_c=25\text{ }^\circ\text{C}$	63	A
		$T_c=100\text{ }^\circ\text{C}$	40	A
$I_{DM}$	Pulse Drain Current Tested ①	$T_c=25\text{ }^\circ\text{C}$	240	A
$P_D$	Maximum Power Dissipation	$T_c=25\text{ }^\circ\text{C}$	100	W
$R_{JJC}$	Thermal Resistance-Junction to Case	1.5	°C/W	
$R_{JJA}$	Thermal Resistance Junction-Ambient	62	°C/W	
<b>Drain-Source Avalanche Ratings</b>				
EAS	Avalanche Energy, Single Pulsed ②	56	mJ	



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VST012N12MS

120V/63A N-Channel Advanced Power MOSFET

Symbol	Parameter	Condition	Min.	Typ.	Max.	Unit
<b>Static Electrical Characteristics @ T<sub>c</sub> = 25°C (unless otherwise stated)</b>						
V <sub>(BR)DSS</sub>	Drain-Source Breakdown Voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	120	--	--	V
I <sub>DSS</sub>	Zero Gate Voltage Drain Current(T <sub>c</sub> =25°C)	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V	--	--	1	μA
	Zero Gate Voltage Drain Current(T <sub>c</sub> =125°C)	V <sub>DS</sub> =100V, V <sub>GS</sub> =0V	--	--	100	μA
I <sub>GSS</sub>	Gate-Body Leakage Current	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V	--	--	±100	nA
V <sub>GS(TH)</sub>	Gate Threshold Voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250μA	1.3	2.0	2.6	V
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance <sup>③</sup>	V <sub>GS</sub> =10V, I <sub>D</sub> =20A	--	11.5	14	mΩ
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance <sup>③</sup>	V <sub>GS</sub> =4.5V, I <sub>D</sub> =10A	--	13.0	16	mΩ
<b>Dynamic Electrical Characteristics @ T<sub>c</sub> = 25°C (unless otherwise stated)</b>						
R <sub>g</sub>	Gate Resistance	V <sub>DS</sub> =30V, V <sub>GS</sub> =0V, f=1MHz	--	1.8	--	Ω
C <sub>iss</sub>	Input Capacitance		--	3910	--	pF
C <sub>oss</sub>	Output Capacitance		--	305	--	pF
C <sub>rss</sub>	Reverse Transfer Capacitance		--	230	--	pF
Q <sub>g</sub>	Total Gate Charge	V <sub>DS</sub> =60V, I <sub>D</sub> =30A, V <sub>GS</sub> =10V	--	54	--	nC
Q <sub>gs</sub>	Gate-Source Charge		--	13	--	nC
Q <sub>gd</sub>	Gate-Drain Charge		--	22	--	nC
<b>Switching Characteristics</b>						
t <sub>d(on)</sub>	Turn-on Delay Time	V <sub>DD</sub> =60V, I <sub>D</sub> =20A, R <sub>G</sub> =6.8Ω, V <sub>GS</sub> =10V	--	24	--	nS
t <sub>r</sub>	Turn-on Rise Time		--	85	--	nS
t <sub>d(off)</sub>	Turn-Off Delay Time		--	55	--	nS
t <sub>f</sub>	Turn-Off Fall Time		--	90	--	nS
<b>Source- Drain Diode Characteristics@ T<sub>c</sub> = 25°C (unless otherwise stated)</b>						
V <sub>SD</sub>	Forward on voltage	I <sub>SD</sub> =20A, V <sub>GS</sub> =0V	--	0.79	1.2	V
t <sub>rr</sub>	Reverse Recovery Time	T <sub>j</sub> =25°C, I <sub>sd</sub> =10A, V <sub>GS</sub> =0V di/dt=100A/μs	--	50	--	nS
Q <sub>rr</sub>	Reverse Recovery Charge		--	145	--	nC

NOTE:

- ① Repetitive rating; pulse width limited by max. junction temperature.
- ② Limited by T<sub>Jmax</sub>, starting T<sub>J</sub> = 25°C, L = 0.5mH, R<sub>G</sub> = 25Ω, I<sub>AS</sub> = 15A, V<sub>GS</sub> = 10V. Part not recommended for use above this value
- ③ Pulse width ≤ 300μs; duty cycle≤ 2%.

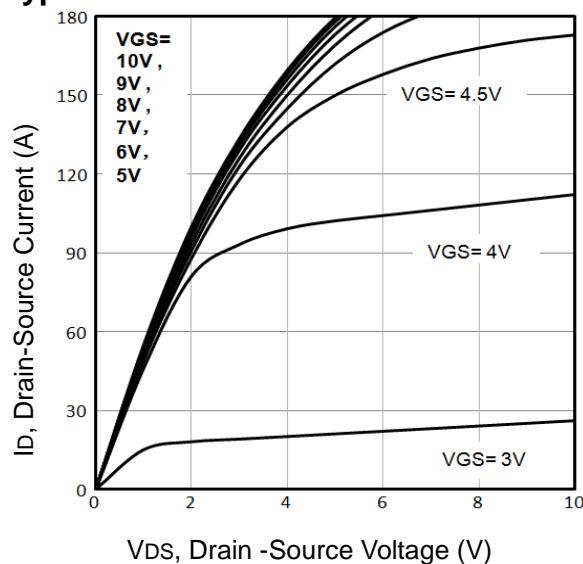


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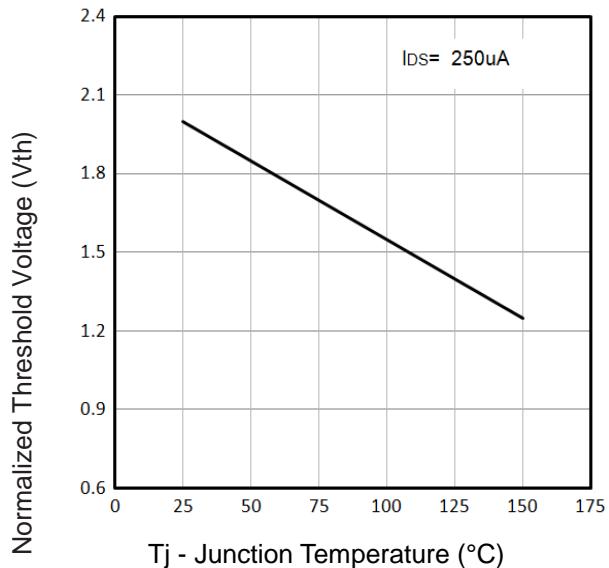
**VST012N12MS**

**120V/63A N-Channel Advanced Power MOSFET**

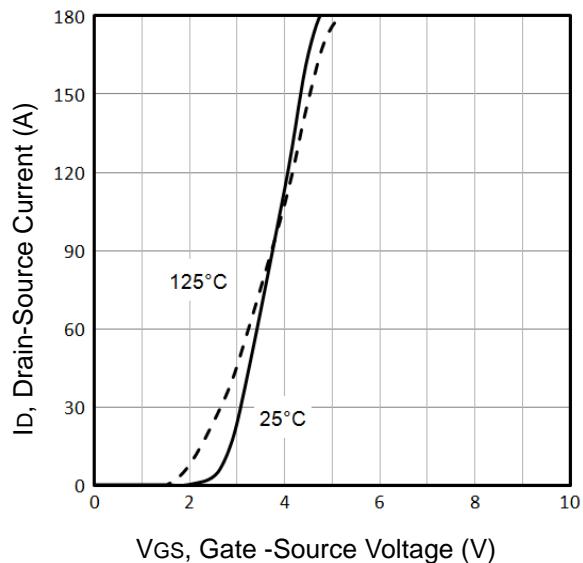
### Typical Characteristics



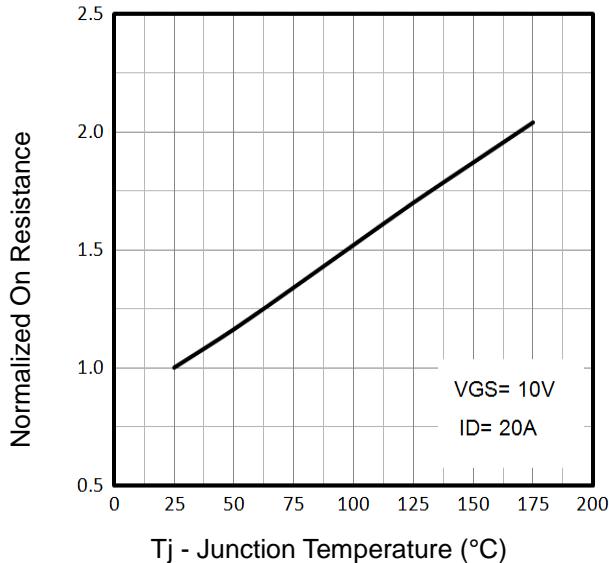
**Fig1.** Typical Output Characteristics



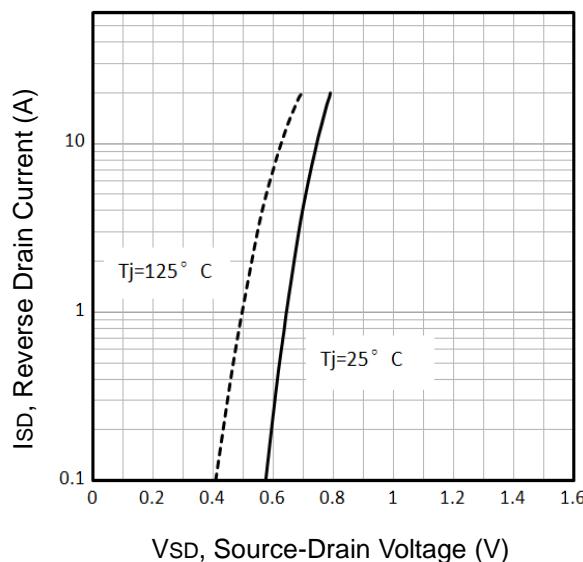
**Fig2.** Normalized Threshold Voltage Vs. Temperature



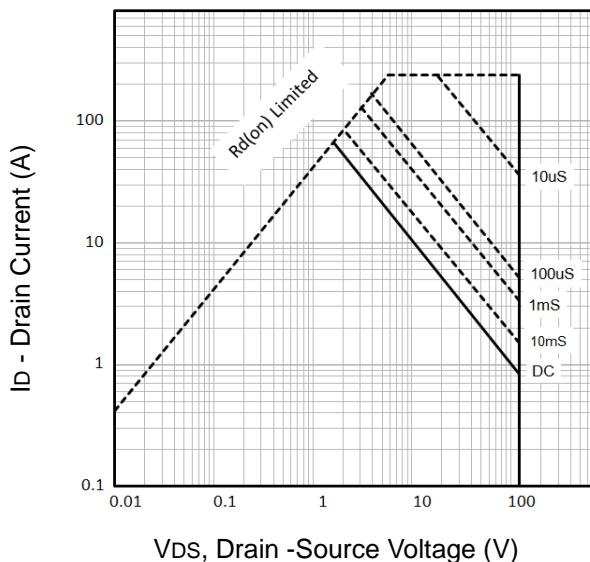
**Fig3.** Typical Transfer Characteristics



**Fig4.** Normalized On-Resistance Vs. Temperature



**Fig5.** Typical Source-Drain Diode Forward Voltage



**Fig6.** Maximum Safe Operating Area

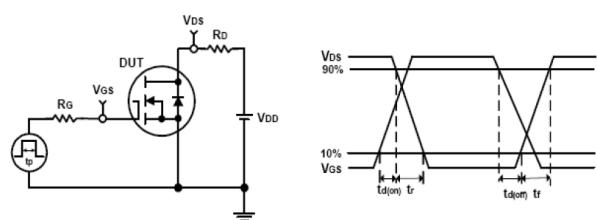
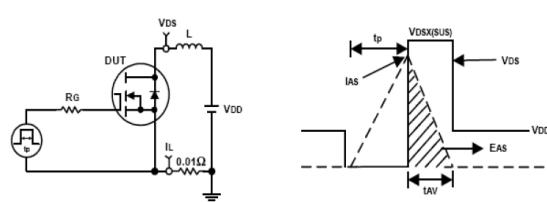
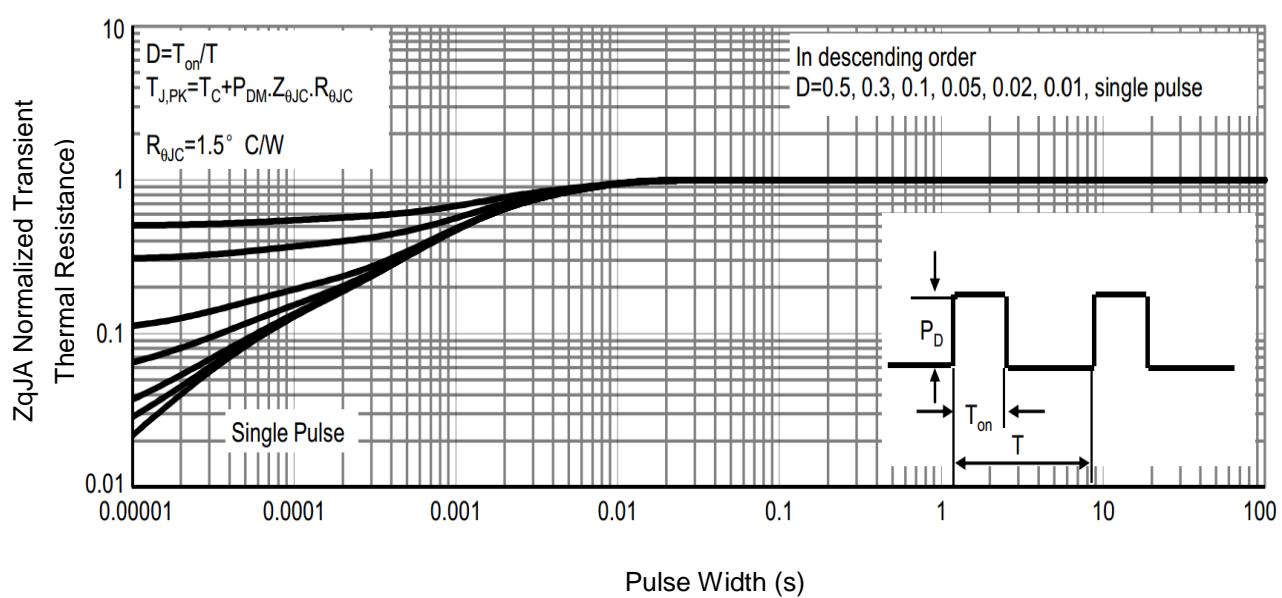
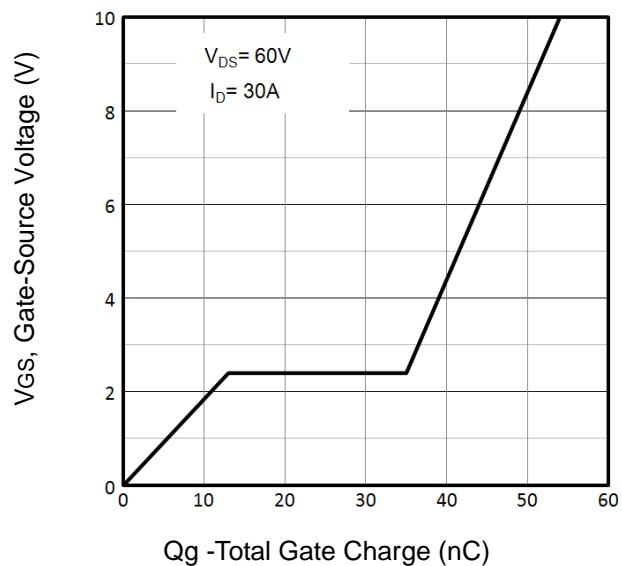
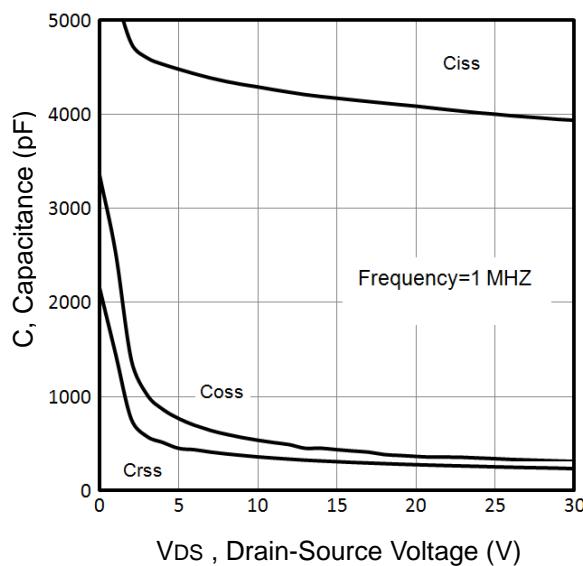


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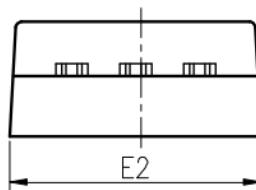
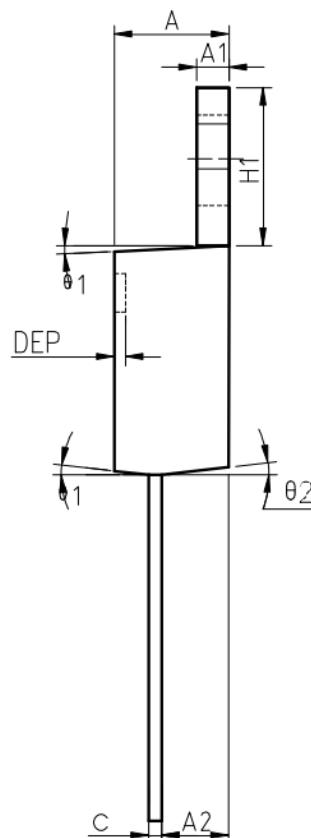
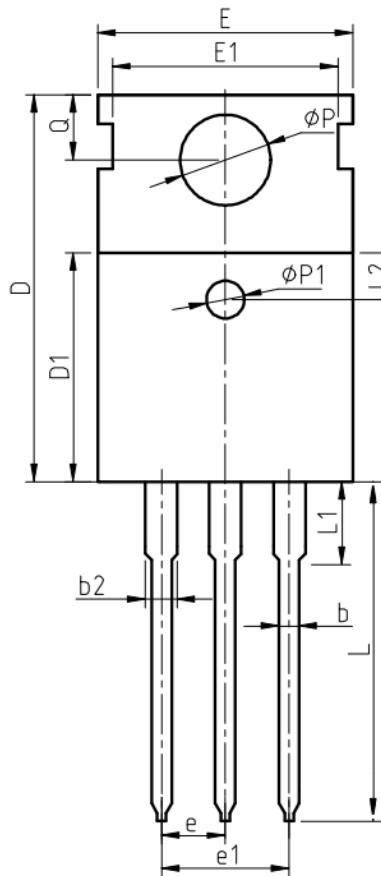
**120V/63A N-Channel Advanced Power MOSFET**

## Typical Characteristics





## TO-220AB Package Outline



Symbol	Dimensions (unit: mm)		
	Min	Typ	Max
A	4.30	4.52	4.70
A1	1.15	1.30	1.40
A2	2.20	2.40	2.60
b	0.70	0.80	1.00
b2	1.17	1.32	1.50
c	0.45	0.50	0.61
D	15.30	15.65	15.90
D1	9.00	9.20	9.40
DEP	0.05	0.10	0.25
E	9.66	9.90	10.28
E1	-	8.70	-
E2	9.80	10.00	10.20
φP1	1.40	1.50	1.60
e	2.54 BSC		
e1	5.08 BSC		
H1	6.40	6.50	6.80
L	12.70		14.27
L1			3.95
L2	2.40	2.50	2.60
φP	3.53	3.60	3.70
Q	2.70	2.80	2.90
θ1	5 °	7 °	9 °
θ2	1 °	3 °	5 °

### Notes:

1. Refer to JEDEC TO-220 variation AB
2. Dimension "D" and "E" do NOT include mold flash. Mold flash shall not exceed 0.127mm per side.

## Customer Service

### Sales and Service:

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